

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Applicants:

Date: May 29, 2002

Beaman et al.

Group Art Unit: 2858

Serial No.: 08/756,830

Examiner: V. Nguyen

Filed: November 20, 1996

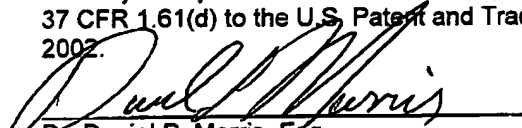
Docket No.: YO995-023XX

For: A HIGH DENSITY INTEGRAL TEST PROBE AND FABRICATION METHOD

Assistant Commissioner for Patents  
Washington, D. C. 20231

## CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this Status Letter (1 page) is being facsimile transmitted under Rule 37 CFR 1.61(d) to the U.S. Patent and Trademark Office to (703) 308-7382 on May 29, 2002.

  
Dr. Daniel P. Morris, Esq.  
Reg. No. 32,053

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STATUS LETTER

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Applicants paid the Issue Fee for the referenced application on February 1, 1999. Attached is a copy of the signed fee transmittal form and a return postcard indicating that it was received by the USPTO on February 1, 1999. Applicants request a status of when this application will issue.

Respectfully submitted,

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